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 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

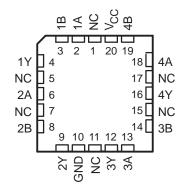
These devices contain four independent 2-input positive-AND gates. They perform the Boolean functions $Y = A \cdot B$ or $Y = \overline{A} + \overline{B}$ in positive logic.

The SN54ALS08 and SN54AS08 are characterized for operation over the full military temperature range of -55° C to 125° C. The SN74ALS08 and SN74AS08 are characterized for operation from 0°C to 70°C.

| FUNCTION TABLE (each gate) | | | | | | | | | |
|-------------------------------|-----|--------|--|--|--|--|--|--|--|
| INP | UTS | OUTPUT | | | | | | | |
| Α | В | Y | | | | | | | |
| Н | Н | Н | | | | | | | |
| L | Х | L | | | | | | | |
| Х | L | L | | | | | | | |

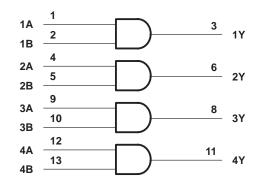
SN54ALS08, SN54AS08 . . . J PACKAGE SN74ALS08, SN74AS08 . . . D OR N PACKAGE (TOP VIEW)

SN54ALS08, SN54AS08 . . . FK PACKAGE (TOP VIEW)

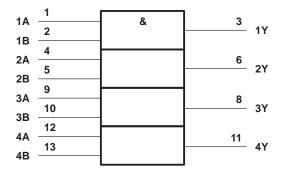


NC - No internal connection

logic diagram (positive logic)



logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for the D, J, and N packages.



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

| Supply voltage, V _{CC} Input voltage, V _I | | |
|--|-----------|--------------------|
| Operating free-air temperature range, TA: | SN54ALS08 | –55°C to 125°C |
| | SN74ALS08 | 0°C to 70°C |
| Storage temperature range | | 65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

| | | SN54ALS08 | |)8 | SN | | | |
|-----|---------------------------------|-----------|-----|------|-----|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| VCC | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| VIH | High-level input voltage | 2 | | | 2 | | | V |
| | Level Second Second and the sec | | | 0.8‡ | | | 0.8 | V |
| VIL | Low-level input voltage | | | 0.7§ | | | | V |
| ЮН | High-level output current | | | -0.4 | | | -0.4 | mA |
| IOL | Low-level output current | | | 4 | | | 8 | mA |
| TA | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

[‡] Applies over temperature range – 55°C to 70°C

§ Applies over temperature range 70°C to 125°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | | | SN | SN54ALS08 | | | 74ALS | 8 | |
|-----------------|----------------------------|---------------------------|--------------------|-----------|------|--------------------|-------|------|------|
| PARAMETER | TEST C | TEST CONDITIONS | | TYP¶ | MAX | MIN | TYP¶ | MAX | UNIT |
| VIK | $V_{CC} = 4.5 V,$ | I _I = -18 mA | | | -1.5 | | | -1.5 | V |
| V _{OH} | V_{CC} = 4.5 V to 5.5 V, | I _{OH} = -0.4 mA | V _{CC} -2 | 2 | | V _{CC} -2 | 2 | | V |
| Max | | $I_{OL} = 4 \text{ mA}$ | | 0.25 | 0.4 | | 0.25 | 0.4 | |
| VOL | $V_{CC} = 4.5 V$ | $I_{OL} = 8 \text{ mA}$ | | | | | 0.35 | 0.5 | V |
| l | $V_{CC} = 5.5 V,$ | $V_{I} = 7 V$ | | | 0.1 | | | 0.1 | mA |
| Ιн | V _{CC} = 5.5 V, | V _I = 2.7 V | | | 20 | | | 20 | μA |
| ١ _{١L} | V _{CC} = 5.5 V, | V _I = 0.4 V | | | -0.1 | | | -0.1 | mA |
| IO# | V _{CC} = 5.5 V, | V _O = 2.25 V | -20 | | -112 | -30 | | -112 | mA |
| ІССН | V _{CC} = 5.5 V, | V _I = 4.5 V | | 1.3 | 2.4 | | 1.3 | 2.4 | mA |
| ICCL | V _{CC} = 5.5 V, | $V_{I} = 0$ | | 2.2 | 4 | | 2.2 | 4 | mA |

¶ All typical values are at V_{CC} = 5 V, T_A = 25° C.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.



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switching characteristics (see Figure 1)

| PARAMETER | FROM (INPUT) | то (оитрит) | CL RL | = 50 pF = 500 Ω = MIN t | | | UNIT |
|------------------|-----------------|----------------|----------|-------------------------------|-----|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| ^t PLH | A or B | V | 2 | 14 | 4 | 14 | |
| ^t PHL | AUB | T T | 2 | 12.5 | 3 | 10 | ns |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[‡]

| Supply voltage, V _{CC} Input voltage, V _I | |
|--|----------------|
| Operating free-air temperature range, T _A : SN54AS08 | |
| SN74AS08 | 0°C to 70°C |
| Storage temperature range | –65°C to 150°C |

Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

| | | SN54AS08 | | S | | | | |
|----------|--------------------------------|----------|-----|-----|-----|-----|-----|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | UNIT |
| VCC | Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| VIH | High-level input voltage | 2 | | | 2 | | | V |
| V_{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V |
| IOH | High-level output current | | | -2 | | | -2 | mA |
| IOL | Low-level output current | | | 20 | | | 20 | mA |
| TA | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | 7507.0 | | S | SN54AS08 | | | N74AS08 | 8 | |
|------------------|-------------------------------------|--------------------------|--------------------|----------|------|--------------------|---------|------|------|
| PARAMETER | TEST C | ONDITIONS | MIN | TYP§ | MAX | MIN | TYP§ | MAX | UNIT |
| VIK | V _{CC} = 4.5 V, | lı = -18 mA | | | -1.2 | | | -1.2 | V |
| VOH | $V_{CC} = 4.5 V \text{ to } 5.5 V,$ | $I_{OH} = -2 \text{ mA}$ | V _{CC} -2 |) | | V _{CC} -2 | 2 | | V |
| VOL | $V_{CC} = 4.5 V,$ | I _{OL} = 20 mA | | 0.35 | 0.5 | | 0.35 | 0.5 | V |
| lį | V _{CC} = 5.5 V, | $V_{I} = 7 V$ | | | 0.1 | | | 0.1 | mA |
| ЧН | V _{CC} = 5.5 V, | V _I = 2.7 V | | | 20 | | | 20 | μΑ |
| ١ _{١L} | $V_{CC} = 5.5 V,$ | $V_{I} = 0.4 V$ | | | -0.5 | | | -0.5 | mA |
| ۱ ₀ ¶ | V _{CC} = 5.5 V, | V _O = 2.25 V | -30 | | -112 | -30 | | -112 | mA |
| Іссн | V _{CC} = 5.5 V, | VI = 4.5 V | | 5.8 | 9.3 | | 5.8 | 9.3 | mA |
| ICCL | V _{CC} = 5.5 V, | $V_{I} = 0$ | | 14.9 | 24 | | 14.9 | 24 | mA |

§ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

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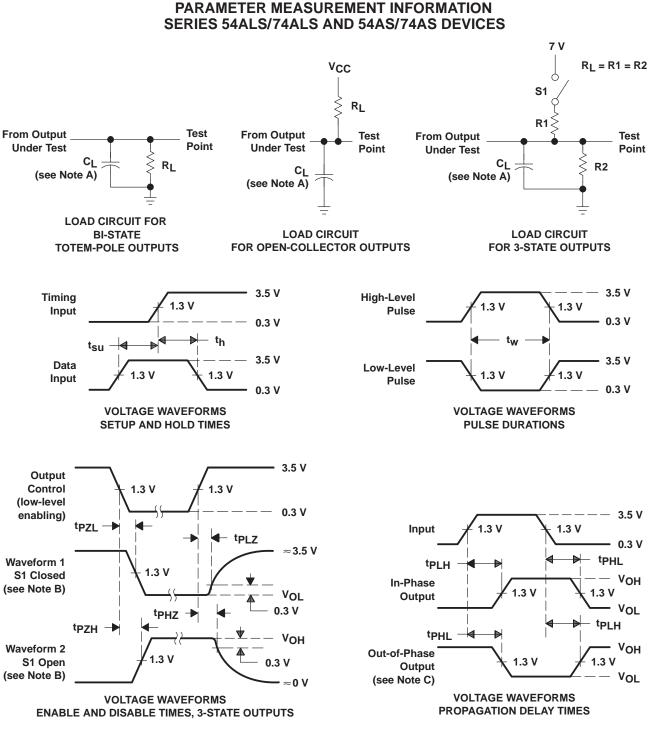
switching characteristics (see Figure 1)

| PARAMETER | FROM (INPUT) | то (оитрит) | CL RL | = 50 pF = 500 Ω = MIN t | | | UNIT |
|------------------|-----------------|----------------|----------|-------------------------------|-----|-----|------|
| | | | MIN | MAX | MIN | MAX | |
| ^t PLH | A or B | V | 1 | 6.5 | 1 | 5.5 | |
| ^t PHL | AUID | T | 1 | 6.5 | 1 | 5.5 | ns |

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_r = t_f = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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15-Oct-2009

PACKAGING INFORMATION

| 5962-86842012A ACTIVE LCCC FK 20 1 TBD POST-PLATE N / A for Pkg Ty 5962-8684201CA ACTIVE CDIP J 14 1 TBD A42 N / A for Pkg Ty 5962-8684201DA ACTIVE CCP W 14 1 TBD A42 N / A for Pkg Ty JM38510/37401B2A ACTIVE LCCC FK 20 1 TBD POST-PLATE N / A for Pkg Ty JM38510/37401BCA ACTIVE CDIP J 14 1 TBD A42 N / A for Pkg Ty SN54ALS08J ACTIVE CDIP J 14 1 TBD A42 N / A for Pkg Ty SN74ALS08D ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DR ACTIVE SOIC D 14 250 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DR ACTIVE SOIC D 14 2500 | ype |
|---|-------|
| 5962-8684201DA ACTIVE CFP W 14 1 TBD A42 N / A for Pkg Ty JM38510/37401B2A ACTIVE LCCC FK 20 1 TBD POST-PLATE N / A for Pkg Ty JM38510/37401BCA ACTIVE CDIP J 14 1 TBD PA42 N / A for Pkg Ty SN54ALS08J ACTIVE CDIP J 14 1 TBD A42 N / A for Pkg Ty SN54ALS08J ACTIVE CDIP J 14 1 TBD A42 N / A for Pkg Ty SN74ALS08D ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DE4 ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DR4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DR4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level | |
| JM38510/37401B2AACTIVELCCCFK201TBDPOST-PLATEN / A for Pkg TyJM38510/37401BCAACTIVECDIPJ141TBDA42N / A for Pkg TySN54ALS08JACTIVECDIPJ141TBDA42N / A for Pkg TySN54ALS08JACTIVECDIPJ141TBDA42N / A for Pkg TySN74ALS08DACTIVESOICD141TBDA42N / A for Pkg TySN74ALS08DE4ACTIVESOICD1450Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DE4ACTIVESOICD1450Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DG4ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DR4ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DR4ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DR64ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NAACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NR64ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSR64ACTIVEPDIP <td>/pe</td> | /pe |
| JM38510/37401BCA ACTIVE CDIP J 14 1 TBD A42 N / A for Pkg Ty SN54ALS08J ACTIVE CDIP J 14 1 TBD A42 N / A for Pkg Ty SN54ALS08J ACTIVE CDIP J 14 1 TBD A42 N / A for Pkg Ty SN54ALS08D ACTIVE CDIP J 14 1 TBD A42 N / A for Pkg Ty SN74ALS08D ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08DE4 ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08DR4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08DR64 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08DR64 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08NR64 ACTIVE PDIP | |
| SN54ALS08JACTIVECDIPJ141TBDA42N / A for Pkg TySN54AS08JACTIVECDIPJ141TBDA42N / A for Pkg TySN74ALS08DACTIVESOICD1450Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DE4ACTIVESOICD1450Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DG4ACTIVESOICD1450Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DRACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DRE4ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DRE4ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DRG4ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRACTIVEPDIPN1425Pb-FreeCU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08NSRACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSR4ACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br) | /pe |
| SN54AS08JACTIVECDIPJ141TBDA42N / A for Pkg TySN74ALS08DACTIVESOICD1450Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DE4ACTIVESOICD1450Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DG4ACTIVESOICD1450Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DG4ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DRACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DRE4ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08N3OBSOLETEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08NSRACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRE4ACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRG4ACTIVESONS142000Green (RoHS & CU NIPDAU <t< td=""><td>уре</td></t<> | уре |
| SN74ALS08D ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DE4 ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DE4 ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DG4 ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DR ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DRE4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DRE4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08DRG4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-U SN74ALS08NR ACTIVE PDIP N 14 25 Pb-Free CU NIPDAU N / A for Pkg Ty SN74ALS08NS OBSOLETE PDIP N 14 | уре |
| N74ALS08DE4ACTIVESOICD1450Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DG4ACTIVESOICD1450Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DRACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DRACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DRE4ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08DRG4ACTIVESOICD142500Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (ROHS)SN74ALS08N3OBSOLETEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (ROHS)SN74ALS08NSRACTIVESONS142000Green (RoHS & CU NIPDAUN / A for Pkg Ty (ROHS)SN74ALS08NSRE4ACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRG4ACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRG4ACTIVESONS142000Green (RoHS & CU NIPDAULevel-1-260C-U no Sb/Br) | уре |
| N74ALS08DG4ACTIVESOICD1450Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-USN74ALS08DRACTIVESOICD142500Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-USN74ALS08DRE4ACTIVESOICD142500Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-USN74ALS08DRG4ACTIVESOICD142500Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-USN74ALS08DRG4ACTIVESOICD142500Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-USN74ALS08NACTIVEPDIPN1425Pb-Free (RoHS)Cu NIPDAUN / A for Pkg TySN74ALS08N3OBSOLETEPDIPN14TBDCall TICall TISN74ALS08NSRACTIVEPOIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg TySN74ALS08NSRACTIVESONS142000Green (RoHS & (ROHS)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRE4ACTIVESONS142000Green (RoHS & (RoHS)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRG4ACTIVESONS142000Green (RoHS & (RoHS)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRG4ACTIVESONS142000Green (RoHS & (RoHS)CU NIPDAULevel-1-260C-U no Sb/Br) | JNLIM |
| N74ALS08DRACTIVESOICD142500Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U Level-1-260C-U no Sb/Br)SN74ALS08DRE4ACTIVESOICD142500Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U Level-1-260C-U no Sb/Br)SN74ALS08DRG4ACTIVESOICD142500Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U Level-1-260C-U no Sb/Br)SN74ALS08NACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08N3OBSOLETEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08NE4ACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08NSRACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRE4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRG4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br) | JNLIM |
| N74ALS08DRE4ACTIVESOICD142500Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U Level-1-260C-U no Sb/Br)SN74ALS08DRG4ACTIVESOICD142500Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08N3OBSOLETEPDIPN14TBDCall TICall TISN74ALS08N44ACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08NSRACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRE4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRG4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br) | JNLIM |
| SN74ALS08DRG4ACTIVESOICD142500Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U Level-1-260C-USN74ALS08NACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08N3OBSOLETEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08NE4ACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08NSRACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRG4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRG4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br) | JNLIM |
| SN74ALS08NACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08N3OBSOLETEPDIPN14TBDCall TICall TISN74ALS08N4ACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08N5RACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRE4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRG4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br) | JNLIM |
| (RoHS)SN74ALS08N3OBSOLETEPDIPN14TBDCall TICall TISN74ALS08NE4ACTIVEPDIPN1425Pb-Free (RoHS)CU NIPDAUN / A for Pkg Ty (RoHS)SN74ALS08NSRACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRE4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br)SN74ALS08NSRG4ACTIVESONS142000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-U no Sb/Br) | JNLIM |
| SN74ALS08NE4 ACTIVE PDIP N 14 25 Pb-Free (RoHS) CU NIPDAU N / A for Pkg Ty (RoHS) SN74ALS08NSR ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08NSRE4 ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08NSRE4 ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08NSRG4 ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) | /pe |
| (RoHS) SN74ALS08NSR ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08NSRE4 ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08NSRE4 ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08NSRG4 ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) | |
| no Sb/Br) SN74ALS08NSRE4 ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) SN74ALS08NSRG4 ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) | /pe |
| no Sb/Br) SN74ALS08NSRG4 ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) | JNLIM |
| no Šb/Br) | JNLIM |
| SN74AS08D ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U | JNLIM |
| no Sb/Br) | JNLIM |
| SN74AS08DE4 ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) | JNLIM |
| SN74AS08DG4 ACTIVE SOIC D 14 50 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) | JNLIM |
| SN74AS08DR ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) | JNLIM |
| SN74AS08DRE4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) | JNLIM |
| SN74AS08DRG4 ACTIVE SOIC D 14 2500 Green (RoHS & CU NIPDAU Level-1-260C-U no Sb/Br) | JNLIM |
| SN74AS08N ACTIVE PDIP N 14 25 Pb-Free CU NIPDAU N / A for Pkg Ty (RoHS) | /pe |
| SN74AS08N3 OBSOLETE PDIP N 14 TBD Call TI Call TI | |
| SN74AS08NE4 ACTIVE PDIP N 14 25 Pb-Free CU NIPDAU N / A for Pkg Ty (RoHS) | /pe |
| SN74AS08NSR ACTIVE SO NS 14 2000 Green (RoHS & CU NIPDAU Level-1-260C-U | JNLIM |

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RUMENTS

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| | | | | | | no Sb/Br) | | |
| SN74AS08NSRE4 | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AS08NSRG4 | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SNJ54ALS08FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| SNJ54ALS08J | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N / A for Pkg Type |
| SNJ54ALS08W | ACTIVE | CFP | W | 14 | 1 | TBD | A42 | N / A for Pkg Type |
| SNJ54AS08FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type |
| SNJ54AS08J | ACTIVE | CDIP | J | 14 | 1 | TBD | A42 | N / A for Pkg Type |
| SNJ54AS08W | ACTIVE | CFP | W | 14 | 1 | TBD | A42 | N / A for Pkg Type |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| All dimensions are nominal Device | Package | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------------------------|---------|--------------------|----|------|--------------------------|--------------------------|---------|---------|---------|------------|-----------|------------------|
| SN74ALS08DR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74ALS08NSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74AS08DR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74AS08NSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ALS08DR | SOIC | D | 14 | 2500 | 346.0 | 346.0 | 33.0 |
| SN74ALS08NSR | SO | NS | 14 | 2000 | 346.0 | 346.0 | 33.0 |
| SN74AS08DR | SOIC | D | 14 | 2500 | 346.0 | 346.0 | 33.0 |
| SN74AS08NSR | SO | NS | 14 | 2000 | 346.0 | 346.0 | 33.0 |

J (R-GDIP-T**) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MLCC006B - OCTOBER 1996

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

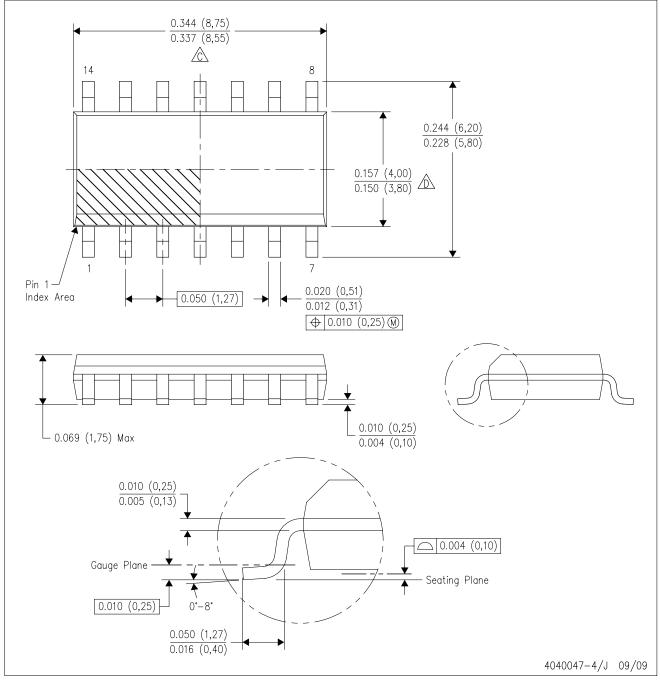
14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
- Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
- E. Reference JEDEC MS-012 variation AB.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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